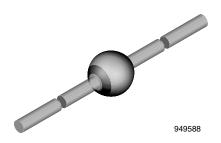
# **BYW172D, BYW172F, BYW172G**

## Vishay Semiconductors

# **Fast Avalanche Sinterglass Diode**



#### **MECHANICAL DATA**

Case: SOD-64

Terminals: plated axial leads, solderable per MIL-STD-750,

method 2026

Polarity: color band denotes cathode end

**Mounting position:** any **Weight:** approx. 858 mg

#### **FEATURES**

- · Glass passivated junction
- · Hermetically sealed package
- Low reverse current
- · Soft recovery characteristics
- · Low forward voltage drop
- · High pulse current capability
- Material categorization:
   For definitions of compliance please see www.vishay.com/doc?99912





COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

• Fast rectification diode in S.M.P.S

ORDERING INFORMATION (Example)						
DEVICE NAME	ORDERING CODE	TAPED UNITS	MINIMUM ORDER QUANTITY			
BYW172G	BYW172G-TR	2500 per 10" tape and reel	12 500			
BYW172G	BYW172G-TAP	2500 per ammopack	12 500			

PARTS TABLE					
PART	TYPE DIFFERENTIATION	PACKAGE			
BYW172D	V <sub>R</sub> = 200 V; I <sub>F(AV)</sub> = 3 A	SOD-64			
BYW172F	V <sub>R</sub> = 300 V; I <sub>F(AV)</sub> = 3 A	SOD-64			
BYW172G	V <sub>R</sub> = 400 V; I <sub>F(AV)</sub> = 3 A	SOD-64			

ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT		
	See electrical characteristics	BYW172D	$V_R = V_{RRM}$	200	V		
Reverse voltage = repetitive peak reverse voltage		BYW172F	$V_R = V_{RRM}$	300	V		
Tollago		BYW172G	$V_R = V_{RRM}$	V <sub>RRM</sub> 300 V V <sub>RRM</sub> 400 V	V		
Peak forward surge current	$t_p = 10 \text{ ms}$ , half sine wave		I <sub>FSM</sub>	100	Α		
Average forward current			I <sub>F(AV)</sub>	3	Α		
Non repetitive reverse avalanche energy	I <sub>(BR)R</sub> = 1 A		E <sub>R</sub>	20	mJ		
Junction and storage temperature range			$T_i = T_{sta}$	- 55 to + 175	°C		

MAXIMUM THERMAL RESISTANCE (T <sub>amb</sub> = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Junction ambient	Lead length I = 10 mm, T <sub>L</sub> = constant	$R_{thJA}$	25	K/W	
Surction ambient	On PC board with spacing 25 mm	$R_{thJA}$	70	K/W	

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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I <sub>F</sub> = 3 A		$V_{F}$	-	-	1.1	V
Forward voltage	I <sub>F</sub> = 9 A		V <sub>F</sub>	-	-	1.5	V
Reverse current	$V_R = V_{RRM}$		I <sub>R</sub>	-	-	1	μΑ
neverse current	$V_R = V_{RRM}$ , $T_j = 100  ^{\circ}C$		I <sub>R</sub>	-	-	20	μΑ
Reverse recovery time	$I_F = 0.5 A$ , $I_R = 1 A$ , $I_R = 0.25 A$		t <sub>rr</sub>	-	75	100	ns

### **TYPICAL CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

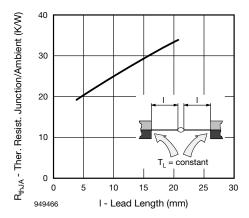


Fig. 1 - Max. Thermal Resistance vs. Lead Length

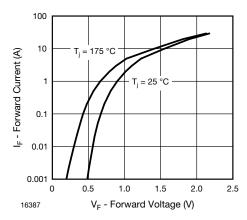


Fig. 2 - Max. Forward Current vs. Forward Voltage

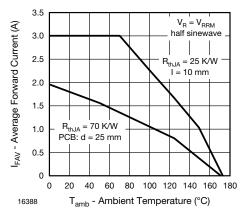


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

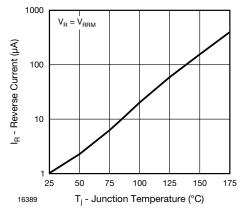
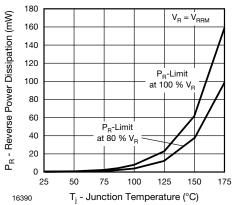


Fig. 4 - Max. Reverse Current vs. Junction Temperature

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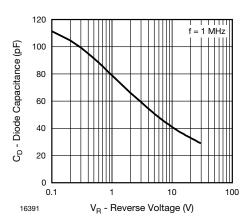


Fig. 6 - Diode Capacitance vs. Reverse Voltage

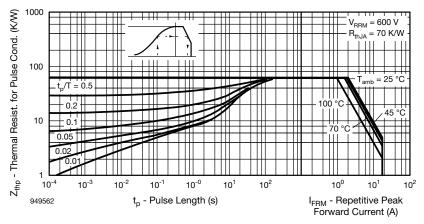
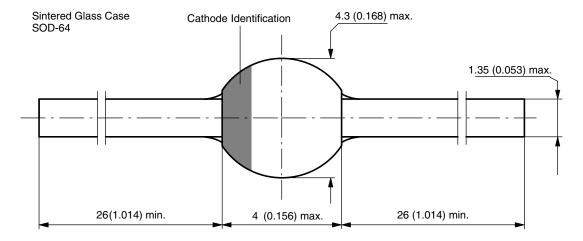


Fig. 7 - Thermal Response

#### PACKAGE DIMENSIONS in millimeters (inches): SOD-64



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